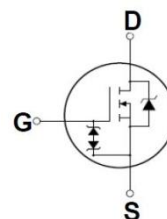
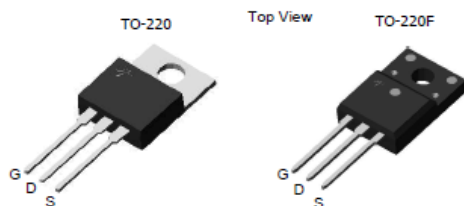


N-channel MOSFET

## Features

- Low gate charge
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant
- Halogen free package
- JEDEC Qualification

$BV_{DSS}$	$I_D$	$R_{DS(on)MAX}$
600V	2A	<4.0Ω



Device	Package	Marking	Remark
TMP2N60Z / TMPF2N60Z	TO-220 / TO-220F	TMP2N60Z / TMPF2N60Z	RoHS
TMP2N60ZG / TMPF2N60ZG	TO-220 / TO-220F	TMP2N60ZG / TMPF2N60ZG	Halogen Free

## Absolute Maximum Ratings

Parameter	Symbol	TMP2N60Z(G)	TMPF2N60Z(G)	Unit	
Drain-Source Voltage	$V_{DSS}$	600		V	
Gate-Source Voltage	$V_{GS}$	±30		V	
Continuous Drain Current	$I_D$	$T_C = 25\text{ }^\circ\text{C}$	2 *	A	
		$T_C = 100\text{ }^\circ\text{C}$	1.4 *	A	
Pulsed Drain Current (Note 1)	$I_{DM}$	8	8 *	A	
Single Pulse Avalanche Energy (Note 2)	$E_{AS}$	128		mJ	
Repetitive Avalanche Current (Note 1)	$I_{AR}$	2		A	
Repetitive Avalanche Energy (Note 1)	$E_{AR}$	5.2		mJ	
Power Dissipation	$P_D$	$T_C = 25\text{ }^\circ\text{C}$	52	17.3	W
		Derate above 25 °C	0.416	0.138	W/°C
Peak Diode Recovery dv/dt (Note 3)	dv/dt	4.5		V/ns	
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55~150		°C	
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	$T_L$	300		°C	

\* Limited only by maximum junction temperature

## Thermal Characteristics

Parameter	Symbol	TMP2N60Z(G)	TMPF2N60Z(G)	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$	2.4	7.2	°C/W
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	62.5	°C/W

**Electrical Characteristics :  $T_C=25^\circ\text{C}$ , unless otherwise noted**

Parameter	Symbol	Test condition	Min	Typ	Max	Units
<b>OFF</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	600	--	--	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$	--	--	1	$\mu\text{A}$
		$V_{DS} = 480\text{ V}, T_C = 125^\circ\text{C}$	--	--	10	$\mu\text{A}$
Forward Gate-Source Leakage Current	$I_{GSSF}$	$V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$	--	--	70	$\mu\text{A}$
Reverse Gate-Source Leakage Current	$I_{GSSR}$	$V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$	--	--	-70	$\mu\text{A}$

**ON**

Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	2	--	4	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 1.0\text{ A}$	--	3.2	4.0	$\Omega$
Forward Transconductance <sup>(Note 4)</sup>	$g_{FS}$	$V_{DS} = 30\text{ V}, I_D = 1.0\text{ A}$	--	5	--	S

**DYNAMIC**

Input Capacitance	$C_{iss}$	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$	--	400	--	pF
Output Capacitance	$C_{oss}$		--	41	--	pF
Reverse Transfer Capacitance	$C_{rss}$		--	7.5	--	pF

**SWITCHING**

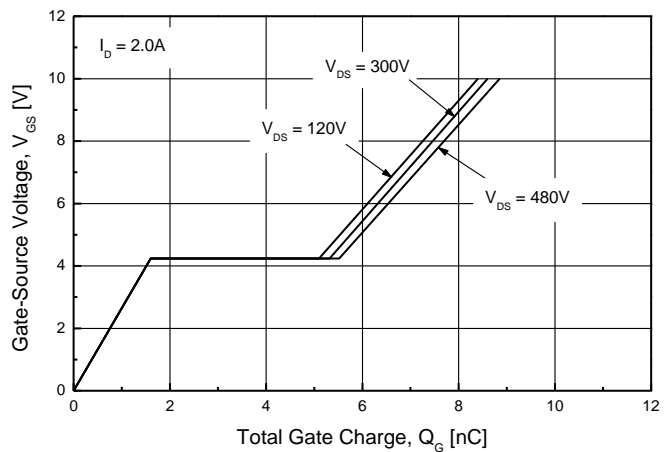
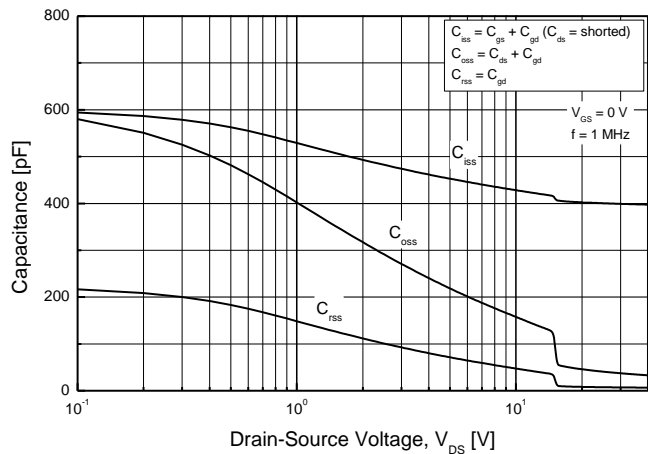
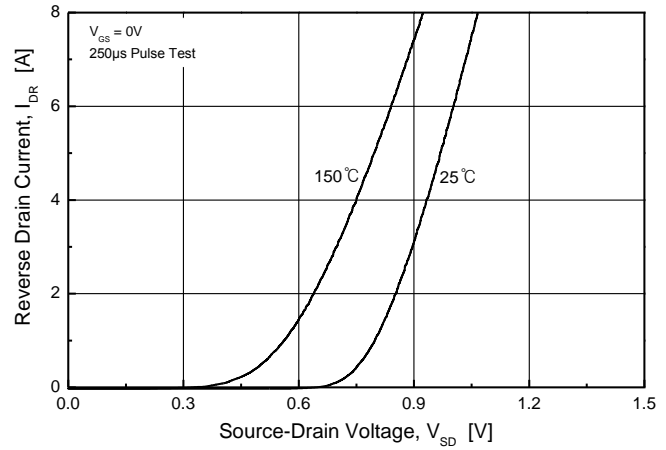
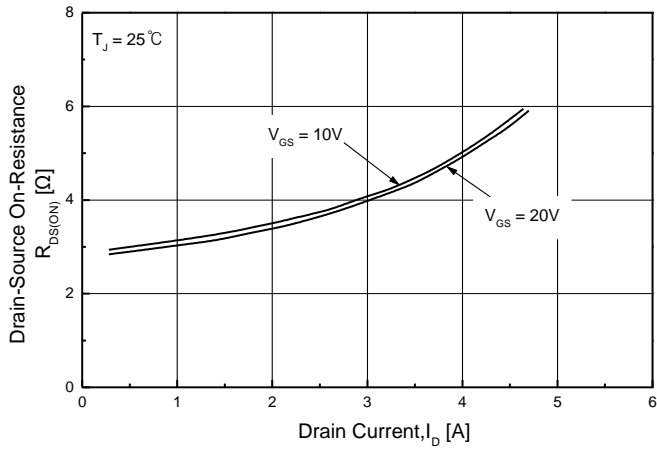
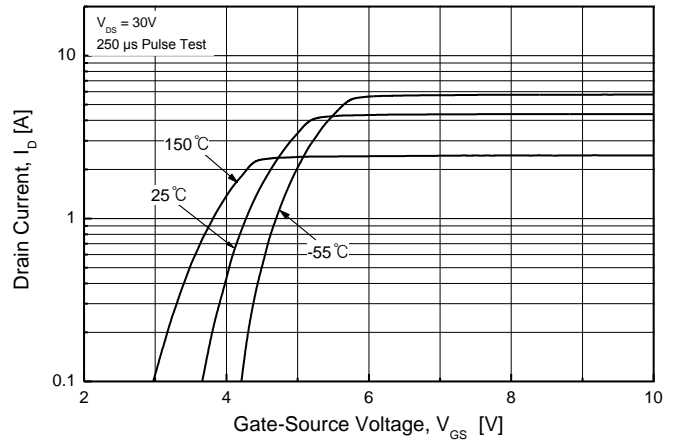
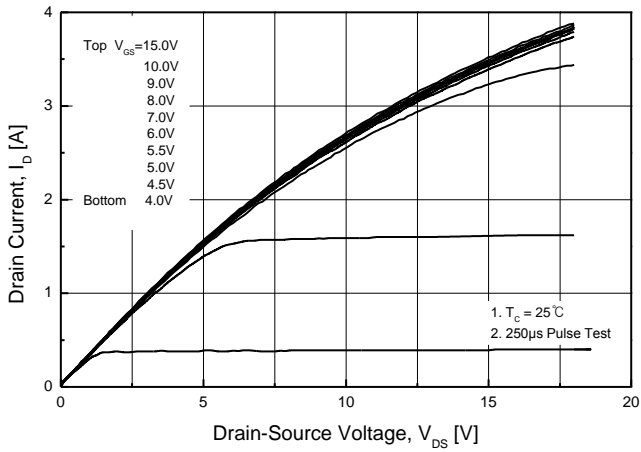
Turn-On Delay Time <sup>(Note 4,5)</sup>	$t_{d(on)}$	$V_{DD} = 300\text{ V}, I_D = 2.0\text{ A},$ $R_G = 25\ \Omega$	--	13	--	ns
Turn-On Rise Time <sup>(Note 4,5)</sup>	$t_r$		--	18	--	ns
Turn-Off Delay Time <sup>(Note 4,5)</sup>	$t_{d(off)}$		--	46	--	ns
Turn-Off Fall Time <sup>(Note 4,5)</sup>	$t_f$		--	20	--	ns
Total Gate Charge <sup>(Note 4,5)</sup>	$Q_g$	$V_{DS} = 480\text{ V}, I_D = 2.0\text{ A},$ $V_{GS} = 10\text{ V}$	--	9.6	--	nC
Gate-Source Charge <sup>(Note 4,5)</sup>	$Q_{gs}$		--	1.6	--	nC
Gate-Drain Charge <sup>(Note 4,5)</sup>	$Q_{gd}$		--	4.3	--	nC

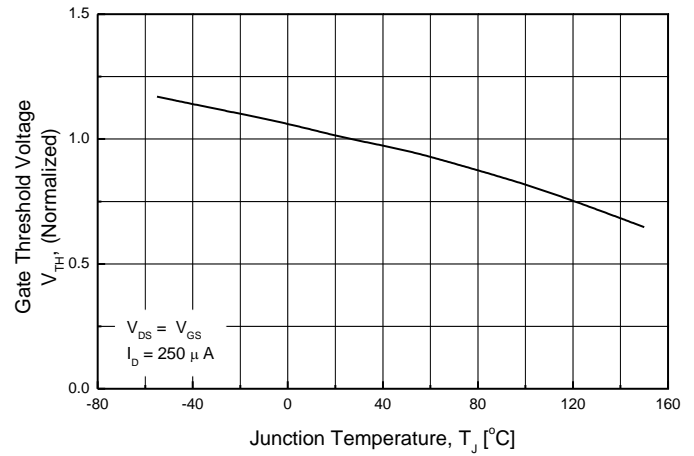
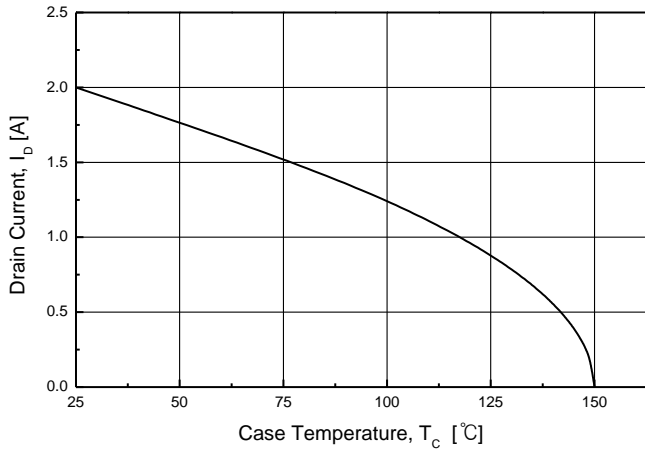
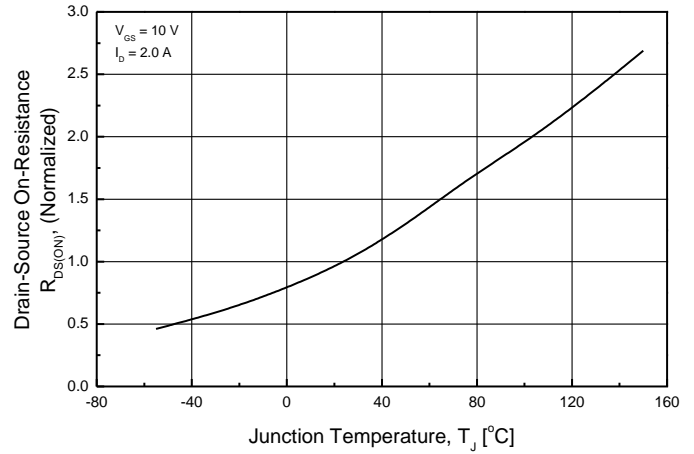
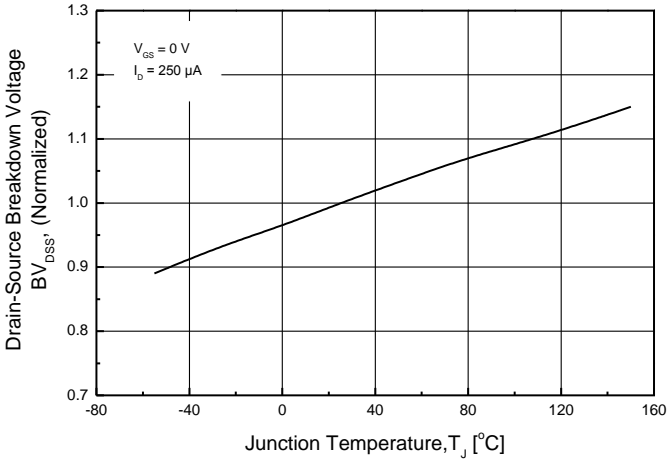
**SOURCE DRAIN DIODE**

Maximum Continuous Drain-Source Diode Forward Current	$I_S$	----	--	--	2	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{SM}$	----	--	--	8	A
Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0\text{ V}, I_S = 2.0\text{ A}$	--	--	1.5	V
Reverse Recovery Time <sup>(Note 4)</sup>	$t_{rr}$	$V_{GS} = 0\text{ V}, I_S = 2.0\text{ A}$ $di_F / dt = 100\text{ A}/\mu\text{s}$	--	241	--	ns
Reverse Recovery Charge <sup>(Note 4)</sup>	$Q_{rr}$		--	0.8	--	$\mu\text{C}$

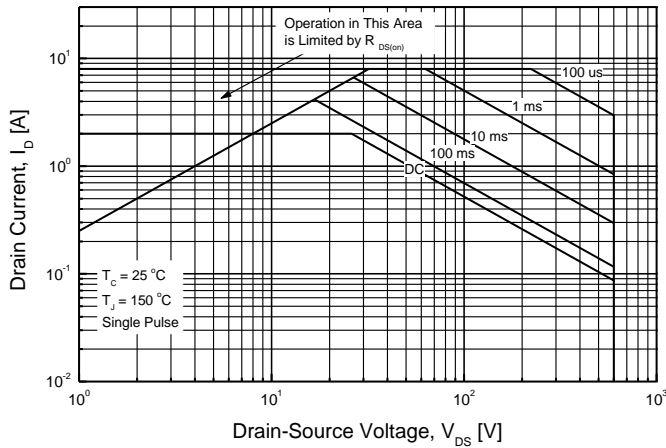
Note :

1. Repetitive rating : Pulse width limited by maximum junction temperature
2.  $L=59\text{mH}, I_{AS} = 2\text{A}, V_{DD} = 50\text{V}, R_G = 25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$
3.  $I_{SD} \leq 2\text{A}, di/dt \leq 200\text{A}/\mu\text{s}, V_{DD} \leq BV_{DS}$ , Starting  $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2\%$
5. Essentially Independent of Operating Temperature Typical Characteristics

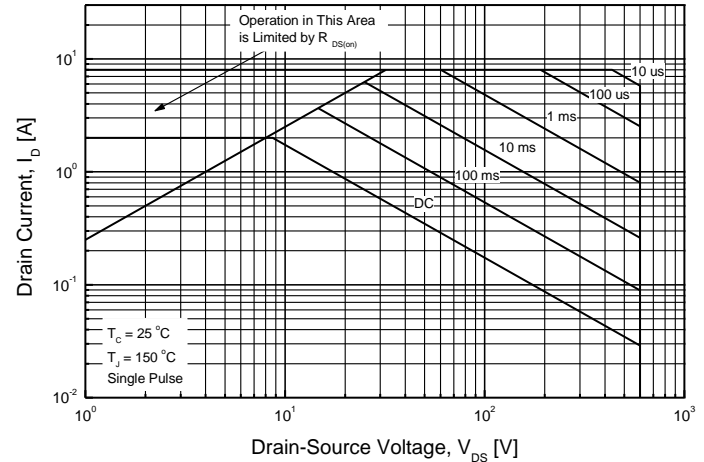




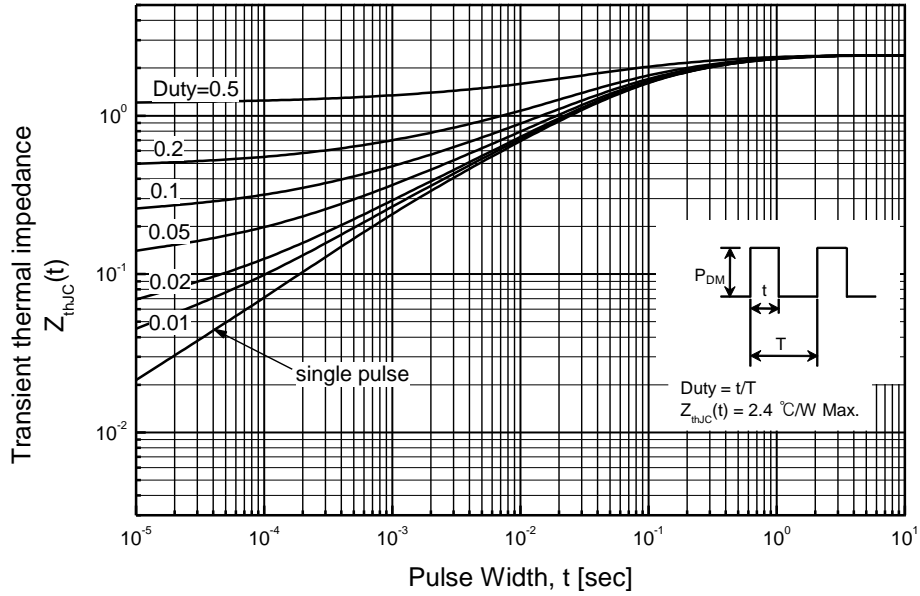
## TMP2N60Z(G)



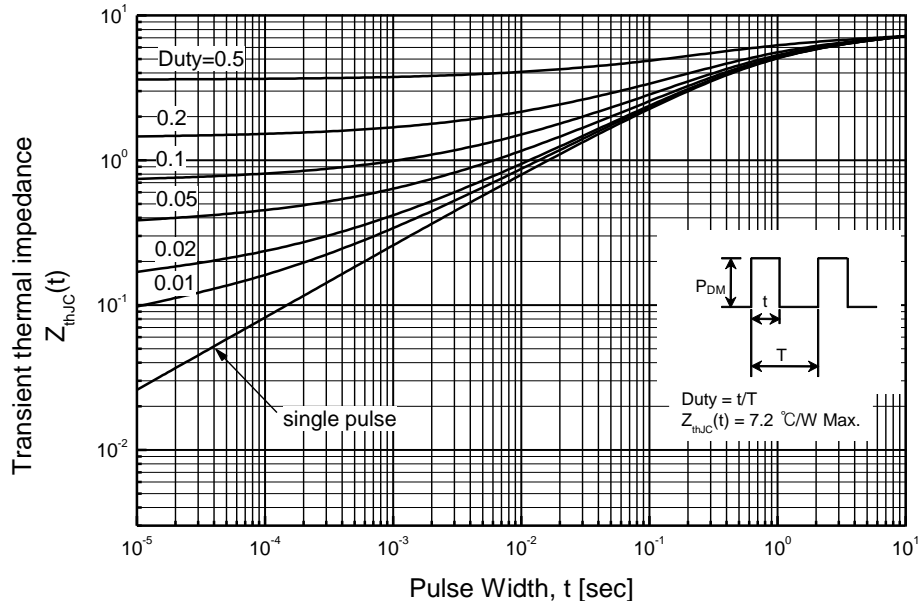
## TMPF2N60Z(G)



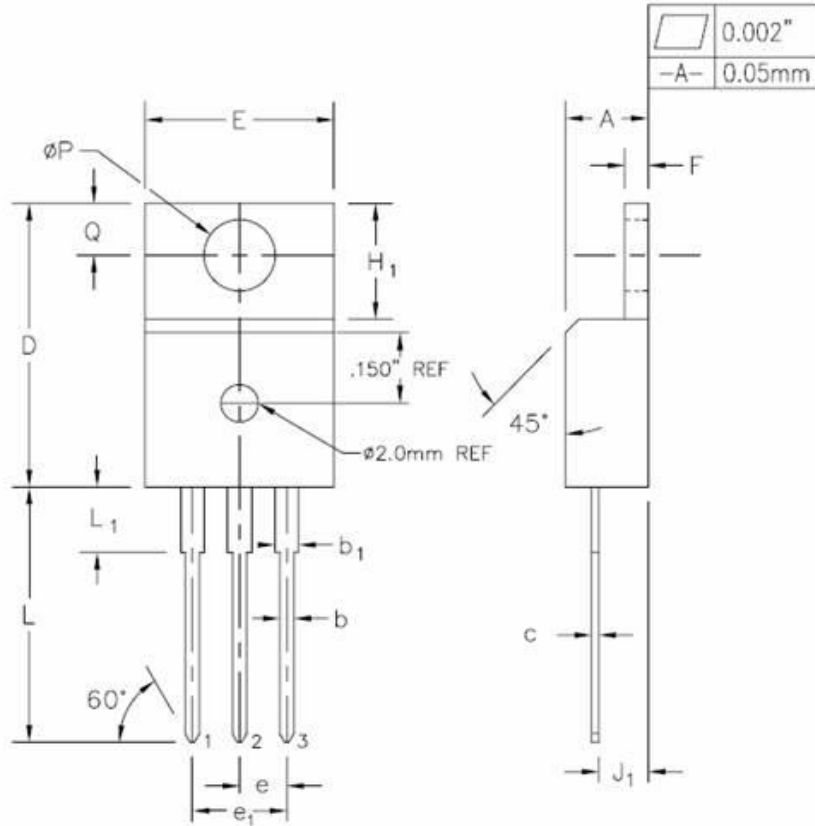
**TMP2N60Z(G)**



**TMPF2N60Z(G)**

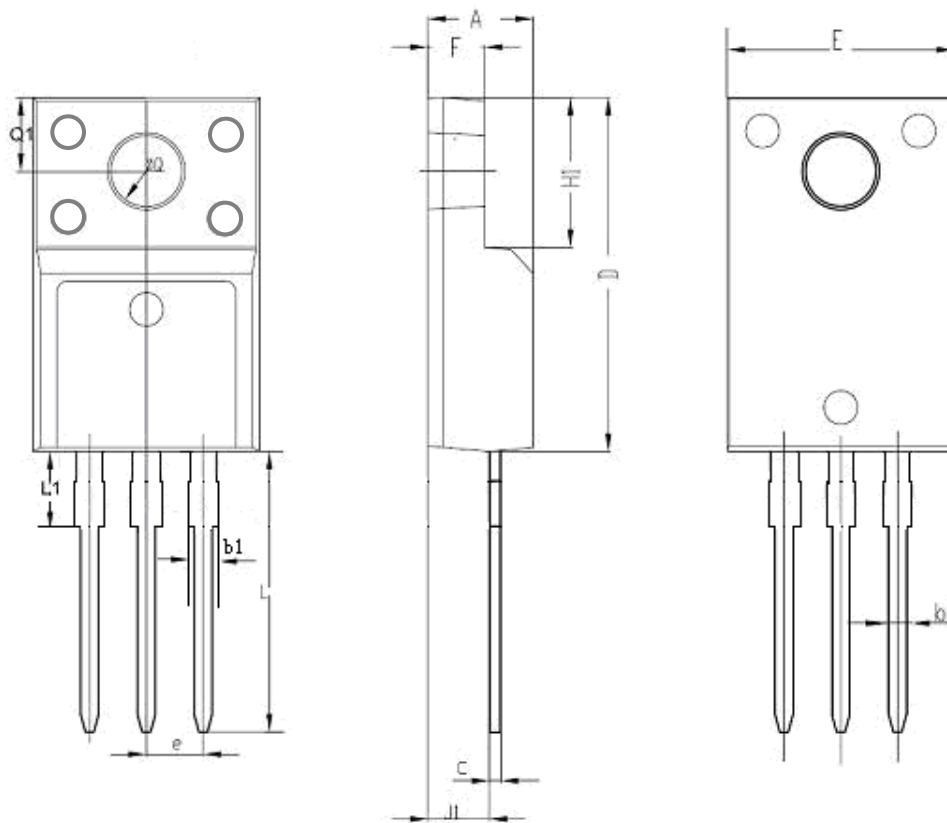


TO-220AB-3L MECHANICAL DATA



SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	0.170	0.180	4.32	4.57	
b	0.028	0.036	0.71	0.91	
b <sub>1</sub>	0.045	0.055	1.15	1.39	
c	0.014	0.021	0.36	0.53	
D	0.590	0.610	14.99	15.49	
E	0.395	0.410	10.04	10.41	
e	0.100 TYP.		2.54 TYP.		
e <sub>1</sub>	0.200 BSC		5.08 BSC		
F	0.048	0.054	1.22	1.37	
H <sub>1</sub>	0.235	0.255	5.97	6.47	
J <sub>1</sub>	0.100	0.110	2.54	2.79	
L	0.530	0.550	13.47	13.97	
L <sub>1</sub>	0.130	0.150	3.31	3.81	2
∅P	0.149	0.153	3.79	3.88	
Q	0.102	0.112	2.60	2.84	

TO-220F-3L MECHANICAL DATA



SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.178	0.194	4.53	4.93	
b	0.028	0.036	0.71	0.91	
C	0.018	0.024	0.45	0.60	
D	0.617	0.633	15.67	16.07	
E	0.392	0.408	9.96	10.36	
e	0.100 TYP.		2.54TYP.		
H1	0.256	0.272	6.50	6.90	
J1	0.101	0.117	2.56	2.96	
L	0.503	0.519	12.78	13.18	
φQ	0.117	0.133	2.98	3.38	
b1	0.045	0.055	1.15	1.39	
L1	0.114	0.130	2.9	3.3	
Q1	0.122	0.138	3.10	3.50	
F	0.092	0.108	2.34	2.74	